I hereby certify that this correspondence is being facsimile transmitted to the Patent and Tredemark Office, facsimile no (703) 872-9318, on the date shown below.

Dated: 7 7 7 03 Signature: (Deborah Harrell)

Docket No.: YOR91990336US2

(20140-00300-US (PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Conf. No. 8304

Chao-Kun Hu

Application No.: 10/054,605

Group Art Unit: 2815

Filed: November 13, 2001

Examiner: Paul E. Brock, II

For: REDUCED ELECTROMIGRATION AND

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RESPONSE AFTER FINAL UNDER 37 CFR 1.116

M/S AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Final Office Action dated March 4, 2003 (Paper No. 8), please amend the above-identified U.S. patent application as follows:

SUMMARY OF AMENDMENTS

CLAIMS

07/17/2003 AJOHNSO1 00000003 220185 10054605

01 FC:1251

110.00 DA

There are no amendments to the claims.

X A complete listing of all claims ever present in this case in ascending order with status identifier is presented in a separate section.